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(19)

(54) METHOD OF MANUFACTURING FLUORESCENT SCREEN OF COLOR PICTURE TUBE

(71) We, HITACHI, LTD., a Corporation organized under the laws of Japan of 5—1, 1-chome, Marunouchi, Chiyoda-ku, Tokyo, Japan, do hereby declare the invention for which we pray that a patent may be granted to us, and the method by which it is to be performed, to be particularly described in and by the following statement:—

This invention relates to a manufacturing method of the fluorescent screen of a color tube and more particularly to that of the fluorescent screen of a negative stripe type in which phosphors are arranged in a number of stripes each stripe having a width narrower than that of each slot formed in the shadow mask incorporated to the cathode-ray tube.

One widely used color tube is of a so-called black stripe type in which black material fills the spaces between adjacent stripes of phosphors of primary colors and which belongs to the above-mentioned type of color picture tube. In the manufacture of this type of color picture tube the inner surface of the faceplate of the panel of the color picture tube is first uniformly coated with photoresist. Next, the photoresist coatings on the portions where the phosphor stripes of three colors of green, blue and red are formed are sequentially and selectively exposed to a light for hardening. Following this, the faceplate is washed out with water for removing parts of the photoresist not exposed to the light, resulting in the formation of a matrix of stripes of photoresist. After this, black material is applied over the entire surface of the faceplate and processed with hydrogen peroxide or the like thereby to remove the remaining parts of the photoresist, whereby the black material coated on the portions where the photoresist has been previously removed remains, while the black material coated on the stripes of the photoresist is removed together with the photoresist coating, with the result that a matrix of stripes of the black material is formed. The spaces between the stripes of the black material where no black material exists are generally called "windows". Next, coating of phosphors of green, blue and red are applied to the respective windows thereby to form a matrix of stripes of green, blue and red phosphors arranged in a predetermined order. Each of the phosphor stripes covers one window and extends at both longitudinal edges thereof over the respective edges of the stripes of the black material which define the window. For example, in forming the stripes of green phosphor, a mixture of green phosphor and photoresist is coated over the entire surface of the face plate where the stripes of black material have been formed, and then only the portions of the coating of the mixture where the stripes of green phosphor are to be formed are selectively exposed to a light for hardening through a mask and then the remaining portions which are not exposed to the light are removed. In this way, the respective matrix stripes of green, blue and red phosphors are formed successively thereby to complete the fluorescent screen. The actual width of each of the stripes of color phosphors is slightly wider than the width of the window, but only a part of the phosphor stripe coated inside the window is effective to reproduce a visible color image. Therefore, the effective width of the stripe of color phosphor is determined by the width of the window.

In the case of the fluorescent screen of the negative stripe type, the width of each phosphor stripe is so designed as to be narrower than that of each slot formed in the shadow-mask to be combined with the screen, i.e. more precisely that of each light profile of the electron beam projected onto the fluorescent screen through each of the slots of the shadow mask. For this purpose, when the portions of the photoresist coating where the windows, on which the phosphor stripes are to be coated, are exposed to light for hardening through the mask at the above-mentioned steps, the width of the profile of the light beam projected onto the photoresist coating through the slots of the mask and the energy of the projected light beam are controlled to form the windows each having a predetermined width. Hitherto, the exposure has been

performed in such a manner that a light source having a predetermined width is located at a predetermined position and a light of the light source is projected onto the photoresist coating through each slot of the mask. This method, however, suffers from a drawback that when the light intensity from the light source changes due to the change of the power source voltage the light energy level applied to the photoresist coating greatly changes. Therefore, it is difficult to form the windows each having a predetermined width.

Accordingly, an object of the present invention is to provide an exposure method which is free from the drawbacks of the prior art and in which the width of the windows changes little even if the intensity of the light emitted from a light source changes due to the voltage change of a power source.

According to the present invention, there is provided a method of manufacturing a negative stripe type fluorescent screen of a color picture tube by the steps of forming a coating of opto-hardening material on the inner surface of the faceplate of the panel of a color picture tube and exposing selectively the coating to a light for hardening thereby to form a matrix of stripes of opto-hardening material, in which said selective exposure is performed by projecting light derived from a single light source having a predetermined width through a slot for each stripe to be formed during such exposure, the slot having a predetermined width and being in a shadow mask located between the inner surface of said faceplate and the light source, onto the coating of opto-hardening material on the faceplate with the light source during such exposure being first located at one position to project the light beam onto the coating of opto-hardening material formed on the faceplate to an extent insufficient adequately to harden the opto-hardening material through the slot before being moved to a second position where it projects the light beam onto the same coating through the same slot to complete the exposure, the projection of the light beam being interrupted during the movement of said single light source between the two positions, said two positions being separated from said inner surface of the faceplate by a predetermined distance and also being separated from each other in the direction of the width of the slot of said shadow mask.

According to another aspect of the invention there is provided a method of manufacturing a negative stripe type of fluorescent screen of a colour picture tube including the steps of forming a coating of opto-hardening material on the inner surface of the faceplate of the panel of a colour picture tube and exposing to light and hardening selectively the coating thereby to form a matrix of stripes of opto-hardening material, in which said selective exposure is performed by projecting light derived only from a pair of light sources each having a predetermined width through a slot for each stripe to be formed during such exposure, the slot having a predetermined width and being in a shadow mask located between said inner surface of said faceplate and said light sources, onto said coating of opto-hardening material formed on said faceplate, said two light sources being separated from said inner surface of the faceplate by a predetermined distance and also being separated from each other in the direction of the width of the slot of said shadow mask and the exposure from one source only being insufficient to harden the opto-hardening material whereby adequate hardening of the opto-hardening material only takes place at areas exposed to light from both sources.

The invention will be further apparent from the following description in connection with the accompanying drawings, in which:

Fig. 1 is a schematic diagram showing the state of exposure according to a prior art method;

Fig. 2 is a diagram showing a distribution of light energy in the exposure shown in Fig. 1;

Fig. 3 is a schematic diagram showing the state of the exposure according to the present invention; and

Fig. 4 is a diagram showing a distribution of light energy in the exposure shown in Fig. 3.

Reference is now made to Fig. 1 in which a power source 3 with a width f, a shadow mask 2 with a slot having a width g and a faceplate 1 are arranged in parallel to one another with a predetermined distance e between the inner surface of the faceplate and the shadow mask 2, and a predetermined distance d between the light source 3 and the shadow mask 2. When the light beam originating from the light source having a width f, is projected through a slot of width g onto the faceplate 1, it produces thereon a light profile having a width $\overline{AF}=C$, as shown in Fig. 1. However, the light from the full width of the light source projects onto only the central portion $\overline{BE}=a$, and the light from a part of the light source width does not project onto the portions $\overline{AB}$ and $\overline{EF}$ at both the sides thereof. Fig. 2 shows a distribution of the light energy on the light profile when the light beam is projected thereonto for a predetermined time period under the condition of Fig. 1. The hardening of photoresist by a light exposure requires a light energy above a predetermined level, although such a light energy level depends on the kind of photoresist to be used. Assume that the light energy

level in this example is h. The photoresist hardens only at the portion $\overline{HK}$ in the graph. If the desired width of the window is b, the width f and the intensity of the light is selected so as to provide the relation $\overline{HK}=b$. In this example, the maximum width of the light profile $\overline{AF}=C$ and the central portion $\overline{BE}=a$ which receives the light from the full width of the light source are respectively given by the equations

$$a=(1+\frac{e}{d})g-(\frac{e}{d})\times f$$

$$c=(1+\frac{e}{d})g+(\frac{e}{d})\times f$$

In order to make change of the stripe width b small even when the luminous intensity of the light source changes, the inclination of the light energy distribution curve must be steep at both sides of the light profile. This inclination changes depending on the width of the light source. For example, in the case of using a large width of the light source, the projected light energy must be distributed as depicted by the dotted line in Fig. 2, in order to obtain a predetermined width b of the window. However, such an energy distribution is not preferable because the inclination of the energy level distribution curve is not sharp around the portions where the energy level is h. A preferable energy distribution is such that on the one hand the inclination is steep at the portions which receive only light derived from a part of the light source width, and on the other hand the projected light energy level at the portion which receives the light derived from the full width of the light source is kept as high as possible relative to the light energy level at the portion of the light profile corresponding to the desired width of the window to be made. In the conventional method, the light source width f is selected to be optimum, so as to satisfy the requirements mentioned above. However, the conventional method can hardly achieve a satisfactorily sharp inclination. Thus, the amount of change of the window width b ranges from 7% to 10% with 10% change of the intensity of exposure light. This needs a strict control of the intensity of exposure light.

An exposure method according to the invention will be described with reference to Fig. 3, in which like symbols are used to designate like parts or portions with those of Fig. 1.

As will be seen from the drawings, in the exposure method according to the invention, a light source with a relatively short width f_1 is located at a position x_1 and illuminates the faceplate 1 through a slot with its width g of the shadow-mask 2. Then, the light source 3 is moved by a distance l to be relocated at a position x_2. During this movement, the light from the light source is extinguished or shielded by using a suitable shielding means (not shown) for preventing the exposure of the faceplate. The subsequent exposure of the faceplate is performed through the illumination of the same light source relocated at the position x_2. Such an exposure produces a light energy distribution P which is the sum of an energy distribution P_1 given by the light source at x_1 and another energy distribution P_2 given by the light source positioned at x_2, insufficient energy being provided by the distribution of P_1 and P_2 by itself adequately to harden the opto-hardening photoresist material. In this case, the luminous intensity, the exposure time and the positions x_1 and x_2 of the light source 3 are so selected that the width $\overline{HK}$ corresponding to the light energy level h requires adequately to harden the opto-hardening photoresist material becomes the width b. Thus, the exposure is performed by using a light source with a shorter width than that of the light source of Fig. 1. This means that the inclination of the energy distribution curve is steep at both the sides of the light profile. Therefore, the exposure method of this invention can restrict to a sufficiently small value the change of the window width b due to the change of the light intensity.

Next, an embodiment of the invention will be explained in comparison with the conventional method. In a black matrix type color picture tube of a size of 20 inches and deflection angle of 90 degrees the dimensions, measured at the central part of the tube, are d=265 mm, e=17 mm, slot width g=219 μ, and stripe width=175 μ. When the faceplate is exposed to a light from a rectangular light source with 2 mm width in accordance with the conventional exposure method, the projected light energy obtained at the boundary of the desired stripe width is 72% of the maximum light energy at the central portion of the light profile, and the stripe width b changes 19 μ when the illumination intensity of the light source changes 10%. On the contrary, in the exposure method of this invention with the use of a rectangular light source with its width 0.8 mm, the exposure of the faceplate is performed by locating the light source in succession in two respective positions laterally distanced 0.6 mm from the centre. The light energy distribution of the profile on the inner face of the faceplate formed by the exposure is shown in Fig. 4. In this illustrative profile, the projected light

energy level at the boundary of the desired stripe width is 64% of that at the central portion. The change of the stripe width b is 11 μ when the illumination intensity changes 10%. Theoretically the invention is capable of reducing the change of stripe width substantially to zero with variation of the light intensity by 50% by using an ideal light source, i.e. line light source, thereby to make the light profile ideal.

In the embodiment heretofore described, a light source is moved once between the two projecting positions. It will be noted that in the above example, having both light projecting positions equidistant from the faceplate for exposure, the durations and illumination intensities of exposure must be equal so as to provide the same effect on hardening the photoresist. Also, the projection of the light must be interrupted during its movement from the one to the other position. If the light were projected continuously during the movement, it would result in the same effect as if a light source having a wider length were used according to the prior method as shown in Fig. 1.

An exposure method is well known in which a ring light source or a rotating light source is used for forming matrix holes (circular holes) each having a smaller diameter than that of each hole of the shadow mask when the fluorescent screen of the dot type color picture tube is exposed. In this exposure method, if the lights from the two points located symmetrical with respect to the center of the ring light source or the center of gyration of the light source were used for exposure, they would form a light profile having a projection light energy distribution as shown in Fig. 4. In fact, however, the lights emitted from the points other than those symmetrical two points prevents the formation of the stepwise distribution curve of the projected light energy as shown in Fig. 2. On the other hand, in the present invention, the lights are originated from two positions spaced from each other. Accordingly, if the light source width and the distance between the light projecting positions are appropriately selected, the light energy distribution exhibits a stepwise configuration. As a result, the exposure method of this invention has excellent effects which are far beyond those attained by the exposure method using the ring or rotating light sources for exposure of the dot type fluorescent screen.

In the foregoing description of the embodiment, light shielding means is used for shielding the light during the light source movement. Alternatively, other suitable ways, for example, directly turning off the power source to the light source may be employed for light shielding.

Moreover, in the example heretofore described, the exposures to light from the respective light projecting positions x_1 and x_2 are performed by moving a single light source However, this may be substituted by a method using different light sources located at the positions x_1 and x_2.

Although the example heretofore described is the case for forming the matrix stripe of black material, the matrix stripe of phosphor may also be formed by the exposure method of this invention. It will be apparent that the exposure method of this invention is applicable whether the matrix stripe is of the continuous type or shorter slot type.

WHAT WE CLAIM IS:—

1. A method of manufacturing a negative stripe type of fluorescent screen of a colour picture tube including the steps of forming a coating of opto-hardening material on the inner surface of the faceplate of the panel of a colour picture tube and exposing to a light and hardening selectively the coating thereby to form a matrix of stripes of opto-hardening material, in which said selective exposure is performed by projecting light derived from a single light source having a predetermined width through a slot for each stripe to be formed during such exposure, the slot having a predetermined width and being in a shadow mask located between the inner surface of said faceplate and the light source, onto the coating of opto-hardening material on the faceplate with the light source during such exposure being first located at one position to project the light beam onto the coating of opto-hardening material formed on the faceplate to an extent insufficient adequately to harden the opto-hardening material through the slot before being moved to a second position where it projects the light beam onto the same coating through the same slot to complete the exposure, the projection of the light beam being interrupted during the movement of said single light source between the two positions, said two positions being separated from said inner surface of the faceplate by a predetermined distance and also being separated from each other in the direction of the width of the slot of said shadow mask.

2. A method of manufacturing a negative stripe type of fluorescent screen of a colour picture tube including the steps of forming a coating of opto-hardening material on the inner surface of the faceplate of the panel of a colour picture tube and exposing to light and hardening selectively the coating thereby to form a matrix of stripes of opto-hardening material, in which said selective exposure is performed by projecting light derived only from a pair of light sources each having a predetermined width through a slot for each stripe to be formed during such exposure, the slot having a predetermined width and being in a shadow mask located between said inner surface of said faceplate and said light sources,

energy level at the boundary of the desired stripe width is 64% of that at the central portion. The change of the stripe width b is 11 μ when the illumination intensity changes 10%. Theoretically the invention is capable of reducing the change of stripe width substantially to zero with variation of the light intensity by 50% by using an ideal light source, i.e. line light source, thereby to make the light profile ideal.

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2. A method of manufacturing a negative stripe type of fluorescent screen of a colour picture tube including the steps of forming a coating of opto-hardening material on the inner surface of the faceplate of the panel of a colour picture tube and exposing to light and hardening selectively the coating thereby to form a matrix of stripes of opto-hardening material, in which said selective exposure is performed by projecting light derived only from a pair of light sources each having a predetermined width through a slot for each stripe to be formed during such exposure, the slot having a predetermined width and being in a shadow mask located between said inner surface of said faceplate and said light sources,

onto said coating of opto-hardening material formed on said faceplate, said two light sources being separated from said inner surface of the faceplate by a predetermined distance and also being separated from each other in the direction of the width of the slot of said shadow mask and the exposure from one source only being insufficient to harden the opto-hardening material whereby adequate hardening of the opto-hardening material only takes place at areas exposed to light from both sources.

3. A method of manufacturing negative stripe type fluorescent screens of colour picture tubes, substantially as hereinbefore described with reference to Figures 3 and 4 of the accompanying drawings.

4. Colour picture tubes having screens manufactured according to the method of any one of the preceding claims.

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